

Film Capacitors

Metallized Polypropylene Film Capacitors (MFP)

Series/Type: B32686S
Date: June 2018

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Metallized polypropylene film capacitors (MFP)

B32686S

Snubber

Typical applications

- Snubbering
- Filtering
- IGBT

Climatic

- Max. operating temperature: 110 °C
- Climatic category (IEC 60068-1:2013): 55/100/56

Construction

- Dielectric: polypropylene (PP)
- Film metallized on one side and metal foils internally connected in series
- Plastic case, epoxy resin sealing (UL 94 V-0)

Features

- Very high pulse strength
- High current
- Highest possible contact reliability
- RoHS-compatible

Terminals

Strap terminals, tinned copper (max. torque 10 Nm)

Marking

Manufacturer's logo, ordering code, style (MFP) rated capaitance (coded), cap. tolerance (code letter), rated DC voltage, date of manufacture (coded)

Delivery mode: Bulk (untaped)

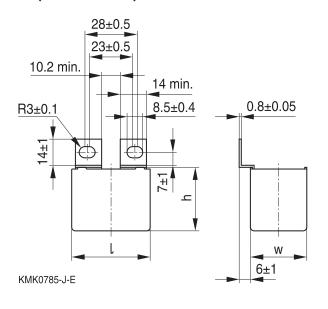




Snubber

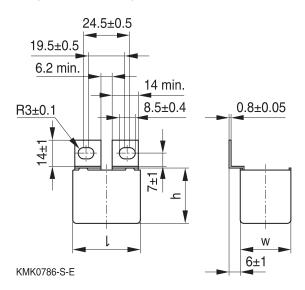
Dimensional drawings

T1 (code no. 561)

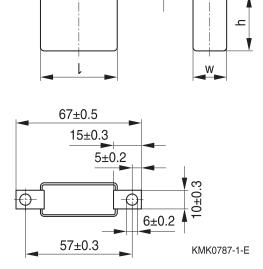


0.5

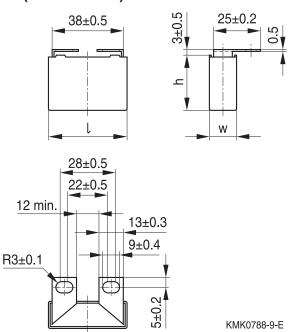
T2 (code no. 562)



T3 (code no. 563)



T4 (code no. 564)



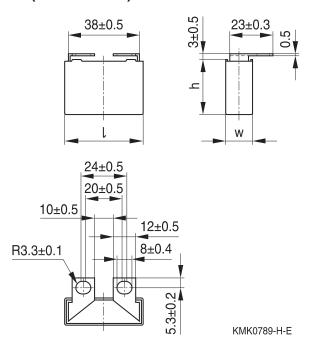




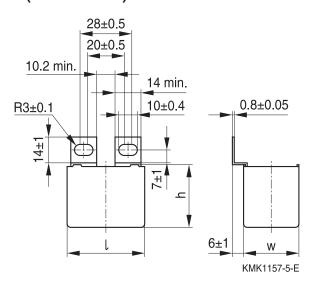
Snubber

Dimensional drawings (continued)

T5 (code no. 565)



T6 (code no. 566)



Overview of available types

Туре	B32686S			
V _R (V DC)	1000	1250	1600	2000
V _{RMS} (V AC)	400	450	450	500
C _R (nF)				
22				
33				
47				
68				
100				
120				
150				
220				
270				
330				
390				
470				
560				
680				





Snubber

Ordering codes and packing units

$\overline{V_R}$	V_{RMS}	C _R	Max. dimensions	I _{RMS}	ESR	Ordering code	Ter-	pcs./
	f≤1kHz		$w \times h \times I$	100 kHz	100 kHz	(composition see	minal	MOQ
V DC	V AC	nF	mm	Α	$m\Omega$	below)		
1000	400	68	$12.0 \times 22.5 \times 42.0$	4.0	20	B32686S0683+563	T3	224
		68	$12.0 \times 22.5 \times 42.0$	4.0	20	B32686S0683+564	T4	384
		100	$12.0 \times 22.5 \times 42.0$	4.5	15	B32686S0104+563	T3	224
		100	$12.0\times22.5\times42.0$	4.5	15	B32686S0104+564	T4	384
		120	$12.0 \times 22.5 \times 42.0$	4.5	13	B32686S0124+563	T3	224
		120	$12.0 \times 22.5 \times 42.0$	4.5	13	B32686S0124+564	T4	384
		150	$14.0 \times 25.0 \times 42.0$	5.5	10	B32686S0154+563	T3	192
		150	$14.0 \times 25.0 \times 42.0$	5.5	10	B32686S0154+564	T4	288
		150	$14.0 \times 25.0 \times 42.0$	5.5	10	B32686S0154+565	T5	288
		220	$16.0 \times 28.5 \times 42.0$	7.0	7	B32686S0224+563	T3	160
		220	$16.0 \times 28.5 \times 42.0$	7.0	7	B32686S0224+564	T4	192
		220	$16.0 \times 28.5 \times 42.0$	7.0	7	B32686S0224+565	T5	192
		270	$18.0 \times 32.5 \times 42.0$	7.5	7	B32686S0274+563	T3	144
		270	$18.0 \times 32.5 \times 42.0$	7.5	7	B32686S0274+564	T4	128
		270	$18.0\times32.5\times42.0$	7.5	7	B32686S0274+565	T5	128
		330	$20.0 \times 39.5 \times 42.0$	8.5	5	B32686S0334+561	T1	96
		330	$20.0 \times 39.5 \times 42.0$	8.5	5	B32686S0334+562	T2	96
		330	$20.0 \times 39.5 \times 42.0$	8.5	5	B32686S0334+563	T3	104
		330	$20.0 \times 39.5 \times 42.0$	8.5	5	B32686S0334+564	T4	96
		330	$20.0 \times 39.5 \times 42.0$	8.5	5	B32686S0334+565	T5	96
		330	$20.0 \times 39.5 \times 42.0$	8.5	5	B32686S0334+566	T6	96
		390	$20.0 \times 39.5 \times 42.0$	9.0	5	B32686S0394+561	T1	96
		390	$20.0 \times 39.5 \times 42.0$	9.0	5	B32686S0394+562	T2	96
		390	$20.0 \times 39.5 \times 42.0$	9.0	5	B32686S0394+563	T3	104
		390	$20.0 \times 39.5 \times 42.0$	9.0	5	B32686S0394+564	T4	96
		390	$20.0 \times 39.5 \times 42.0$	9.0	5	B32686S0394+565	T5	96
		390	$20.0\times39.5\times42.0$	9.0	5	B32686S0394+566	T6	96
		470	$28.0 \times 37.0 \times 42.0$	10.0	3	B32686S0474+561	T1	108
		470	$28.0 \times 37.0 \times 42.0$	10.0	3	B32686S0474+562	T2	108
		470	$28.0 \times 37.0 \times 42.0$	10.0	3	B32686S0474+563	T3	72
		470	$28.0 \times 37.0 \times 42.0$	10.0	3	B32686S0474+566	T6	108

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$





Snubber

Ordering codes and packing units

$\overline{V_R}$	V_{RMS}	C _R	Max. dimensions	I _{RMS}	ESR	Ordering code	Ter-	pcs./
	f≤1kHz		$w \times h \times l$	100 kHz	100 kHz	(composition see	minal	MOQ
V DC	V AC	nF	mm	Α	$m\Omega$	below)		
1000	400	560	$28.0 \times 37.0 \times 42.0$	11.0	3	B32686S0564+561	T1	108
		560	$28.0 \times 37.0 \times 42.0$	11.0	3	B32686S0564+562	T2	108
		560	$28.0 \times 37.0 \times 42.0$	11.0	3	B32686S0564+563	T3	72
		560	$28.0 \times 37.0 \times 42.0$	11.0	3	B32686S0564+566	T6	108
		680	$30.0 \times 45.0 \times 42.0$	12.0	3	B32686S0684+561	T1	48
		680	$30.0 \times 45.0 \times 42.0$	12.0	3	B32686S0684+562	T2	48
		680	$30.0 \times 45.0 \times 42.0$	12.0	3	B32686S0684+563	T3	72
		680	$30.0 \times 45.0 \times 42.0$	12.0	3	B32686S0684+566	T6	48
1250	450	68	$12.0 \times 22.5 \times 42.0$	4.5	20	B32686S7683+563	T3	224
		68	$12.0 \times 22.5 \times 42.0$	4.5	20	B32686S7683+564	T4	384
		100	$14.0 \times 25.0 \times 42.0$	5.0	15	B32686S7104+563	T3	192
		100	$14.0 \times 25.0 \times 42.0$	5.0	15	B32686S7104+564	T4	288
		100	$14.0 \times 25.0 \times 42.0$	5.0	15	B32686S7104+565	T5	288
		120	$14.0\times25.0\times42.0$	5.5	13	B32686S7124+563	T3	192
		120	$14.0 \times 25.0 \times 42.0$	5.5	13	B32686S7124+564	T4	288
		120	$14.0 \times 25.0 \times 42.0$	5.5	13	B32686S7124+565	T5	288
		150	$16.0 \times 28.5 \times 42.0$	6.5	10	B32686S7154+563	T3	160
		150	$16.0 \times 28.5 \times 42.0$	6.5	10	B32686S7154+564	T4	192
		150	$16.0\times28.5\times42.0$	6.5	10	B32686S7154+565	T5	192
		220	$18.0 \times 32.5 \times 42.0$	8.5	7	B32686S7224+563	T3	144
		220	$18.0 \times 32.5 \times 42.0$	8.5	7	B32686S7224+564	T4	128
		220	$18.0\times32.5\times42.0$	8.5	7	B32686S7224+565	T5	128
		270	$20.0 \times 39.5 \times 42.0$	9.0	7	B32686S7274+561	T1	96
		270	$20.0 \times 39.5 \times 42.0$	9.0	7	B32686S7274+562	T2	96
		270	$20.0 \times 39.5 \times 42.0$	9.0	7	B32686S7274+563	T3	104
		270	$20.0 \times 39.5 \times 42.0$	9.0	7	B32686S7274+564	T4	96
		270	$20.0 \times 39.5 \times 42.0$	9.0	7	B32686S7274+565	T5	96
		270	$20.0\times39.5\times42.0$	9.0	7	B32686S7274+566	T6	96
		330	$28.0 \times 37.0 \times 42.0$	10.0	5	B32686S7334+561	T1	108
		330	$28.0 \times 37.0 \times 42.0$	10.0	5	B32686S7334+562	T2	108
		330	$28.0 \times 37.0 \times 42.0$	10.0	5	B32686S7334+563	T3	72
		330	$28.0 \times 37.0 \times 42.0$	10.0	5	B32686S7334+566	T6	108

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$





Snubber

Ordering codes and packing units

$\overline{V_R}$	V _{RMS}	C _R	Max. dimensions	I _{RMS}	ESR	Ordering code	Ter-	pcs./
	f≤1kHz		$w \times h \times I$	100 kHz	100 kHz	(composition see	minal	MOQ
V DC	V AC	nF	mm	Α	$m\Omega$	below)		
1250	450	390	$28.0 \times 37.0 \times 42.0$	11.0	5	B32686S7394+561	T1	108
		390	$28.0 \times 37.0 \times 42.0$	11.0	5	B32686S7394+562	T2	108
		390	$28.0 \times 37.0 \times 42.0$	11.0	5	B32686S7394+563	T3	72
		390	$28.0 \times 37.0 \times 42.0$	11.0	5	B32686S7394+566	T6	108
		470	$30.0 \times 45.0 \times 42.0$	12.0	5	B32686S7474+561	T1	48
		470	$30.0 \times 45.0 \times 42.0$	12.0	5	B32686S7474+562	T2	48
		470	$30.0 \times 45.0 \times 42.0$	12.0	5	B32686S7474+563	T3	72
		470	$30.0 \times 45.0 \times 42.0$	12.0	5	B32686S7474+566	T6	48
1600	450	47	$12.0\times22.5\times42.0$	5.0	30	B32686S1473+563	T3	224
		47	$12.0\times22.5\times42.0$	5.0	30	B32686S1473+564	T4	384
		68	$14.0 \times 25.0 \times 42.0$	6.0	20	B32686S1683+563	T3	192
		68	$14.0 \times 25.0 \times 42.0$	6.0	20	B32686S1683+564	T4	288
		68	$14.0\times25.0\times42.0$	6.0	20	B32686S1683+565	T5	288
		100	$18.0 \times 32.5 \times 42.0$	7.0	15	B32686S1104+563	T3	144
		100	$18.0 \times 32.5 \times 42.0$	7.0	15	B32686S1104+564	T4	128
		100	$18.0\times32.5\times42.0$	7.0	15	B32686S1104+565	T5	128
		120	$18.0 \times 32.5 \times 42.0$	7.5	13	B32686S1124+563	T3	144
		120	$18.0 \times 32.5 \times 42.0$	7.5	13	B32686S1124+564	T4	128
		120	$18.0\times32.5\times42.0$	7.5	13	B32686S1124+565	T5	128
		150	$20.0 \times 39.5 \times 42.0$	8.5	10	B32686S1154+561	T1	96
		150	$20.0 \times 39.5 \times 42.0$	8.5	10	B32686S1154+562	T2	96
		150	$20.0 \times 39.5 \times 42.0$	8.5	10	B32686S1154+563	T3	104
		150	$20.0 \times 39.5 \times 42.0$	8.5	10	B32686S1154+564	T4	96
		150	$20.0 \times 39.5 \times 42.0$	8.5	10	B32686S1154+565	T5	96
		150	$20.0\times39.5\times42.0$	8.5	10	B32686S1154+566	T6	96
		220	$28.0 \times 37.0 \times 42.0$	10.5	7	B32686S1224+561	T1	108
		220	$28.0 \times 37.0 \times 42.0$		7	B32686S1224+562	T2	108
		220	$28.0 \times 37.0 \times 42.0$	10.5	7	B32686S1224+563	T3	72
		220	$28.0 \times 37.0 \times 42.0$	10.5	7	B32686S1224+566	T6	108

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$





Snubber

Ordering codes and packing units

V_R	V _{RMS}	C _R	Max. dimensions	I _{RMS}	ESR	Ordering code	Ter-	pcs./
	f≤1kHz		$w \times h \times I$	100 kHz	100 kHz	(composition see	minal	MOQ
V DC	V AC	nF	mm	Α	$m\Omega$	below)		
1600	450	270	$30.0 \times 45.0 \times 42.0$	11.5	7	B32686S1274+561	T1	48
		270	$30.0 \times 45.0 \times 42.0$	11.5	7	B32686S1274+562	T2	48
		270	$30.0 \times 45.0 \times 42.0$	11.5	7	B32686S1274+563	T3	72
		270	$30.0 \times 45.0 \times 42.0$	11.5	7	B32686S1274+566	T6	48
2000	500	22	$12.0 \times 22.5 \times 42.0$	4.0	70	B32686S2223+563	T3	224
		22	$12.0 \times 22.5 \times 42.0$	4.0	70	B32686S2223+564	T4	384
		33	$14.0 \times 25.0 \times 42.0$	5.0	50	B32686S2333+563	T3	192
		33	$14.0 \times 25.0 \times 42.0$	5.0	50	B32686S2333+564	T4	288
		33	$14.0 \times 25.0 \times 42.0$	5.0	50	B32686S2333+565	T5	288
		47	$16.0 \times 28.5 \times 42.0$	6.0	30	B32686S2473+563	T3	160
		47	$16.0 \times 28.5 \times 42.0$	6.0	30	B32686S2473+564	T4	192
		47	$16.0 \times 28.5 \times 42.0$	6.0	30	B32686S2473+565	T5	192
		68	$18.0 \times 32.5 \times 42.0$	7.5	20	B32686S2683+563	T3	144
		68	$18.0 \times 32.5 \times 42.0$	7.5	20	B32686S2683+564	T4	128
		68	$18.0 \times 32.5 \times 42.0$	7.5	20	B32686S2683+565	T5	128
		100	$20.0\times39.5\times42.0$	8.5	15	B32686S2104+561	T1	96
		100	$20.0 \times 39.5 \times 42.0$	8.5	15	B32686S2104+562	T2	96
		100	$20.0 \times 39.5 \times 42.0$	8.5	15	B32686S2104+563	T3	104
		100	$20.0 \times 39.5 \times 42.0$	8.5	15	B32686S2104+564	T4	96
		100	$20.0 \times 39.5 \times 42.0$	8.5	15	B32686S2104+565	T5	96
		100	$20.0 \times 39.5 \times 42.0$	8.5	15	B32686S2104+566	T6	96
		120	$28.0 \times 37.0 \times 42.0$	9.0	13	B32686S2124+561	T1	96
		120	$28.0 \times 37.0 \times 42.0$	9.0	13	B32686S2124+562	T2	96
		120	$28.0 \times 37.0 \times 42.0$	9.0	13	B32686S2124+563	T3	104
		120	$28.0 \times 37.0 \times 42.0$	9.0	13	B32686S2124+566	T6	96
		150	$28.0\times37.0\times42.0$	10.0	10	B32686S2154+561	T1	108
		150	$28.0 \times 37.0 \times 42.0$	10.0	10	B32686S2154+562	T2	108
		150	$28.0 \times 37.0 \times 42.0$	10.0	10	B32686S2154+563	T3	72
		150	$28.0 \times 37.0 \times 42.0$	10.0	10	B32686S2154+566	T6	108

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $K = \pm 10\%$



B32686S Snubber



Technical data

Operating temperature range	Max. operating temperature T _{op,max}			+110 °C	
	Upper category temperature T _{max}			+100 °C	
	Lower category temperature T _{min}			−55 °C	
	Rated temp	erature	e T _R	+85 °C	
Dissipation factor tan δ at 20 °C	1.0 ⋅ 10 ⁻³ (a	t 10 kH	łz)		
(upper limit values)	3.0 · 10 ⁻³ (a	t 10 kH	łz)		
Insulation resistance R _{ins}	$C_R \le 0.33 \; \mu l$	F	$C_R > 0.33 \mu F$		
or time constant $\tau = C_R \cdot R_{ins}$	100 GΩ		30000 s		
at 20 °C, rel. humidity \leq 65%					
(minimum as-delivered values)					
DC test voltage	$2.0 \cdot V_R$, 2 s	3			
Category voltage V _C	T _{op} (°C)	DC vo	oltage derating	AC voltage derating	
(continuous operation with	$T_{op} \le 85$	$V_C = V$	/ _R	$V_{C,RMS} = V_{RMS}$	
V_{DC} or V_{AC} at $f \le 1$ kHz)	85 <t<sub>op≤100</t<sub>	$V_C = V$	$I_{R} \cdot (165 - T_{op})/80$	$V_{C,RMS} = V_{RMS} \cdot (165 - T_{op})/80$	
Operating voltage V_{op} for	T _{op} (°C)	DC vo	oltage	AC voltage	
short operating periods	(max. hours)		hours)	(max. hours)	
$(V_{DC} \text{ or } V_{AC} \text{ at } f \le 1 \text{ kHz})$	$ T_{op} \le 85 $ $ V_{op} = 1.25 \cdot V_{C} (2000 \text{ h}) $			$V_{op} = 1.0 \cdot V_{C,RMS} (2000 h)$	
	85 <t<sub>op≤100</t<sub>	$V_{op} = \frac{1}{2}$	1.25 · V _C (1000 h)	$V_{op} = 1.0 \cdot V_{C,RMS} (1000 \text{ h})$	
Damp heat test	56 days/40 °C/93% relative humidity				
Limit values after damp heat	Capacitance	e chan	ge ∆C/C	≤ 2%	
test	Dissipation	factor	change Δ tan δ	$\leq 1.0 \cdot 10^{-3}$ (at 10 kHz)	
	Insulation resistance R _{ins}			≥ 50% of minimum	
	or time constant $\tau = C_R \cdot R_{ins}$			as-delivered values	
Reliability:					
Failure rate λ	1 fit (≤ 1 · 1	0 ⁻⁹ /h) a	at 0.5 · V _R , 40 °C		
Service life t _{SL}	200 000 h a	t 1.0 ·	V _B , 85 °C		
<u> </u>				onditions and temperatures,	
	refer to chap	pter "Q	uality, 2 Reliability	, /".	
Failure criteria:					
Total failure	Short circuit	t or ope	en circuit		
Failure due to variation	Capacitance	•		> 10%	
of parameters	Dissipation			4 · upper limit value	
•	Insulation re			< 1500 MΩ (C _R ≤0.33 μF)	
	or time cons			$< 500 \text{ s} (C_R > 0.33 \mu\text{F})$	
	or time come	starit t	- OR Tims	· 000 σ (OH 0.00 μι)	





Snubber

Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in $V/\mu s$.

" k_0 " represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in $V^2/\mu s$.

Note:

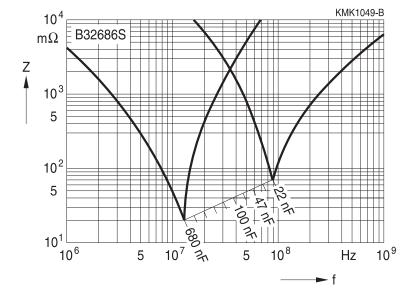
The values of dV/dt and k_0 provided below must not be exceeded in order to avoid damaging the capacitor.

dV/dt and k₀ values

V _R (V DC)	V _{RMS} (V AC)	dV/dt in V/μs	k ₀ in V²/μs
1000	400	2 000	4 000 000
1250	450	2 800	7 000 000
1600	450	3 500	11 000 000
2000	500	4 500	18 000 000

Impedance Z versus frequency f

(typical values)



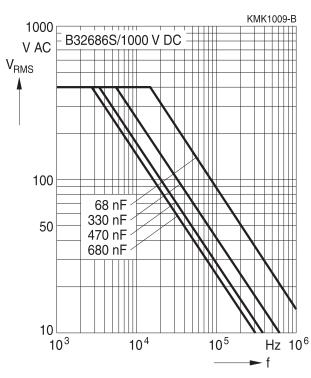


B32686S Snubber

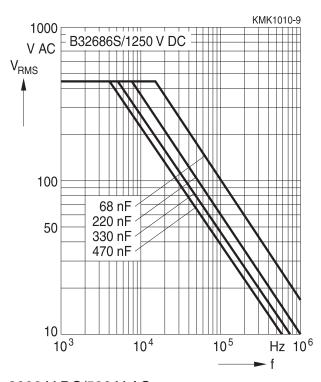
Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, T_A ≤90 °C)

For $T_A > 90$ °C, please refer to "General technical information", section 3.2.3.

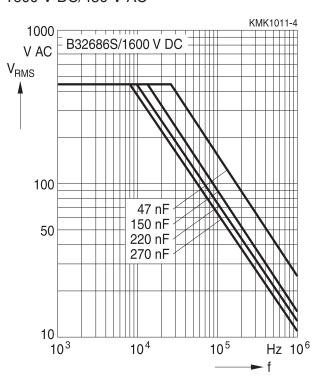
1000 V DC/400 V AC



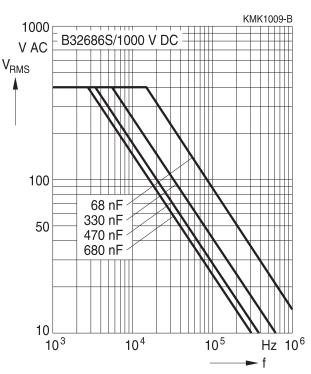
1250 V DC/450 V AC



1600 V DC/450 V AC



2000 V DC/500 V AC







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Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20:2008, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2:2007, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 + 0/-0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder

1.2 Resistance to soldering heat

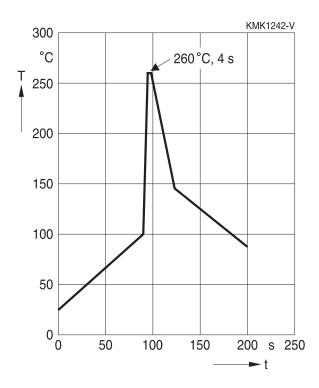
Resistance to soldering heat is tested to IEC 60068-2-20:2008, test Tb, method 1. Conditions:

Serie	S	Solder bath temperature	Soldering time
MKT	boxed (except $2.5 \times 6.5 \times 7.2$ mm) coated uncoated (lead spacing >10 mm)	260 ±5 °C	10 ±1 s
MFP			
MKP	(lead spacing >7.5 mm)		
MKT	boxed (case $2.5 \times 6.5 \times 7.2$ mm)		5 ±1 s
MKP	(lead spacing ≤7.5 mm)		<4 s
MKT	uncoated (lead spacing ≤10 mm) insulated (B32559)		recommended soldering profile for MKT uncoated (lead spacing ≤ 10 mm) and insulated (B32559)



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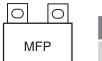
Immersion depth	2.0 +0/-0.5 mm from capacitor body or seating plane	
Shield	Heat-absorbing board, (1.5 ±0.5) mm thick, between	
	capacitor body and liquid solder	
Evaluation criteria:		
Visual inspection	No visible damage	
$\Delta C/C_0$	2% for MKT/MKP/MFP	
$\Delta O/O_0$	5% for EMI suppression capacitors	
$tan \delta$	As specified in sectional specification	

1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
 diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings



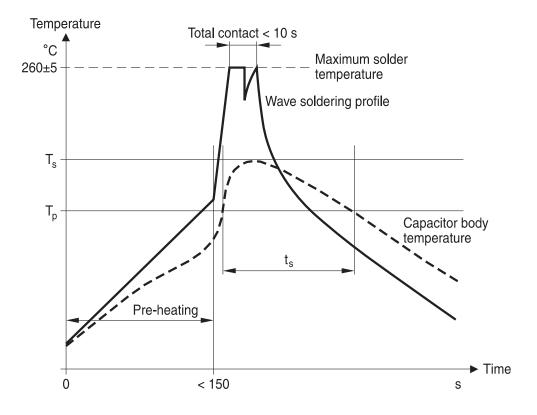


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The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

Recommendations

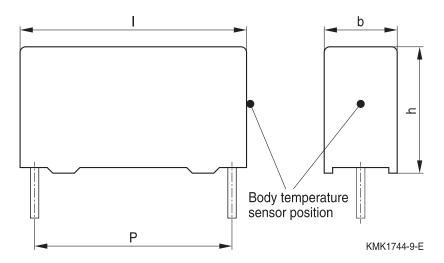
As a reference, the recommended wave soldering profile for our film capacitors is as follows:



T_s: Capacitor body maximum temperature at wave soldering

T_p: Capacitor body maximum temperature at pre-heating

KMK1745-A-E





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Body temperature should follow the description below:

MKP capacitor

During pre-heating: $T_p \le 110 \, ^{\circ}\text{C}$ During soldering: $T_s \le 120 \, ^{\circ}\text{C}$, $t_s \le 45 \, \text{s}$

MKT capacitor

During pre-heating: T_p ≤125 °C

During soldering: T_s ≤160 °C, t_s ≤45 s

When SMD components are used together with leaded ones, the film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.

Leaded film capacitors are not suitable for reflow soldering.

In order to ensure proper conditions for manual or selective soldering, the body temperature of the capacitor (T_s) must be ≤ 120 °C.

One recommended condition for manual soldering is that the tip of the soldering iron should be <360 °C and the soldering contact time should be no longer than 3 seconds.

For uncoated MKT capacitors with lead spacings ≤10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering

Please refer to our Film Capacitors Data Book in case more details are needed.





Snubber

Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.
- Consult us if application is with severe temperature and humidity condition.
- There are no serviceable or repairable parts inside the capacitor. Opening the capacitor or any attempts to open or repair the capacitor will void the warranty and liability of TDK Electronics.
- Please note that the standards referred to in this publication may have been revised in the meantime.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage	Make sure that capacitors are stored within the	4.5
conditions	specified range of time, temperature and humidity conditions.	"Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6:2007. TDK Electronics offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"





Topic	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"

Display of ordering codes for TDK Electronics products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications, on the company website, or in order-related documents such as shipping notes, order confirmations and product labels. The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products.

Detailed information can be found on the Internet under www.tdk-electronics.tdk.com/orderingcodes.

Correlation of data sheet values and modelling tool outputs

Data sheet values and results of design tools may deviate as they have not been derived in the same context.

While data sheets show individual parameter statements without considering a possible dependency to other parameters. Tools model a complete given scenario as input and processed inside the tool.

Furthermore as we constantly strive to improve our models, the results of tools can change over time and be a non-binding indication only.





Snubber

Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α_{C}	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
Α	Capacitor surface area	Kondensatoroberfläche
β_{C}	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
C_R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
ΔC/C	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation	Kapazitätstoleranz (relative Abweichung
	from rated capacitance)	vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔΤ	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
$\Delta tan \delta$	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V/\Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f ₁	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
f_2	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
f_r	Resonant frequency	Resonanzfrequenz
F _D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F_{T}	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
I _C	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)





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Symbol	English	German
I _{RMS}	(Sinusoidal) alternating current,	(Sinusförmiger) Wechselstrom
	root-mean-square value	
i_z	Capacitance drift	Inkonstanz der Kapazität
k_0	Pulse characteristic	Impulskennwert
Ls	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λ_{o}	Constant failure rate during useful	Konstante Ausfallrate in der
	service life	Nutzungsphase
λ_{test}	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P_{diss}	Dissipated power	Abgegebene Verlustleistung
P_{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des
		Entladekreises
R_{i}	Internal resistance	Innenwiderstand
R_{ins}	Insulation resistance	Isolationswiderstand
R_P	Parallel resistance	Parallelwiderstand
R_s	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
tan $\delta_{\scriptscriptstyle D}$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
tan δ_{P}	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
tan δ_{S}	Series component of dissipation factor	Serienanteil des Verlustfaktors
T_A	Temperature of the air surrounding the component	Temperatur der Luft, die das Bauteil umgibt
T_{max}	Upper category temperature	Obere Kategorietemperatur
T_{min}	Lower category temperature	Untere Kategorietemperatur
t _{OL}	Operating life at operating temperature	Betriebszeit bei Betriebstemperatur und
-	and voltage	-spannung
T_op	Operating temperature, $T_A + \Delta T$	Beriebstemperatur, $T_A + \Delta T$
T _R	Rated temperature	Nenntemperatur
T_{ref}	Reference temperature	Referenztemperatur
t_{SL}	Reference service life	Referenz-Lebensdauer





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Symbol	English	German
V_{AC}	AC voltage	Wechselspannung
V_{C}	Category voltage	Kategoriespannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
V_{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V_{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
$V_{\sf FB}$	Fly-back capacitor voltage	Spannung (Flyback)
V_{i}	Input voltage	Eingangsspannung
V_{o}	Output voltage	Ausgangssspannung
V_{op}	Operating voltage	Betriebsspannung
V_p	Peak pulse voltage	Impuls-Spitzenspannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V_R	Rated voltage	Nennspannung
Ŷ _R	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V_{RMS}	(Sinusoidal) alternating voltage,	(Sinusförmige) Wechselspannung
	root-mean-square value	
V_{SC}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung
		"Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß



Important notes

The following applies to all products named in this publication:

- 1. Some parts of this publication contain statements about the suitability of our products for certain areas of application. These statements are based on our knowledge of typical requirements that are often placed on our products in the areas of application concerned. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our products for a particular customer application. As a rule, we are either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always ultimately incumbent on the customer to check and decide whether a product with the properties described in the product specification is suitable for use in a particular customer application.
- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or lifesaving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
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Important notes

- 7. Our manufacturing sites serving the automotive business apply the IATF 16949 standard. The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements ("CSR") TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that only requirements mutually agreed upon can and will be implemented in our Quality Management System. For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.
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